# **LVR Series**

## Low-TCR Current Sense Chips

The resistors are constructed using outstanding TCR level material, which makes

LVR resistors excellent for current sensing

converter. The composition of the resistive material is adjusted to give the LVR series

resistors more resistive stability than the

competition in very small package sizes.

application in battery charger circuit & DC-DC

RoHS

## APPLICATIONS

- Consumer goods
- Computer
- Telecom / Datacom
- Industrial / Power supply
- Alternative Energy
- Car electronics
- Battery

	SERIES SPECIFICATIONS				
Series	Size	Power Rating	Resistance Range	TCR (ppm/°C)	Tolerance
LVR02A	0201	0.1W	5mΩ - 10mΩ	150ppm/°C	1%, 5%
LVR04A	0402	0.125W	2.5mΩ 5mΩ - 20mΩ	±350 ppm/°C ±150 ppm/°C	1%, 5%

### CHARACTERISTICS

Operating	–55°C t	–55°C to +125°C						
Temp. Range	ange							
Power	Standar	d rated power at 70°	C; see chart above					
Rating								
Rated	The DC	or AC (rms) continue	ous working voltage cor-					
Voltage	respond	ling to the rated powe	er is determined by the					
	following	g formula:						
	$V = \sqrt{P}$	xR)						
	or max.	working voltage which	hever is less, where:					
	V = Cor	nt. rated DC or AC (rn	ns) working voltage (V)					
	P = Rated power (W)							
	R = Res	esistance value (Ω)						
Temperature	Size	Resistance range	TCR					
Coeff. of	0201	5mΩ - 10mΩ	±150 ppm/°C					
Resistance	0402	2.5mΩ	±350 ppm/°C					
		5mΩ - 20mΩ	±150 ppm/°C					
Terminations	rminations Cu, Ni, matte Tin							





### **Reflow Soldering Conditions**



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		PERFORMANCE DATA	
Test	Method	Procedure	Requirements
Short time	IEC60115-1 4.13	2.5 times of rated power for 5 seconds at room temperature	±(1%+0.0005Ω)
overload			No visible damage
High	MIL-STD-202-Method	1,000 hours at maximum operating temperature depending on speci-	±(1.0%+0.0005Ω)
Temperature	108	fication, unpowered. No direct impingement of forced air to the parts	
Exposure		Tolerances: 125±5°C	
Moisture	MIL-STD-202-Method	Each temperature / humidity cycle is defined at 8 hours (method 106F),	±(0.5%+0.0005Ω)
Resistance	106	3 cycles / 24 hours for 10d with 25°C / 65°C 95% R.H, without steps 7a	
		& /b, unpowered	
Operational	MIL-STD-202 Method	1,000 hours at 70±2°C applied RCWV. 1.5 hours on, 0.5 hour off, still air	±(1.0%+0.0005Ω)
Life/		requirea	
Endurance	IEC 60115-1 4.25.1		
Solderability -	J-STD-002 test B	Electrical Test not required. Magnification 50X. SMD conditions: 1st step	Well tinned (>95% covered)
wetting		: method B, aging 4 hours at 155°C dry heat; 2nd step: leadfree solder bath at 245±3°C: Dipping time: 3± 0.5 seconds	No visible damage
Moisture	MIL-STD-202 Method	Each temperature / humidity cycle is defined at 8 hours (Method 106G).	$\pm (0.5\% \pm 0.0005\Omega)$
Resistance	106	3 cycles / 24 hours for 10d. with 25°C / 65°C 95% R.H. without steps 7a	No visible damage
		& 7b, un-powered Parts mounted on test board, without condensation	tie tielele aamage
		on parts. Measurement at 24±2 hours after test conclusion.	
Thermal	MIL-STD-202 Method	-55/+125°C. Number of cycles required is 300. Parts mounted on test	±(1.0% + 0.0005Ω)
Shock	107	board. Maximum transfer time is 20 seconds. Dwell time is 15 minutes.	
Board Flex/	IEC 60115-1 4.33	Device mounted on PCB test board as described, only 1 board bend-	±(1.0 % + 0.0005Ω)
Bending		ing required. 2 mm bending. Bending time: 60±1 seconds. Ohmic value	
		checked during bending	
Resistance	MIL-STD-202 Method	Condition B, no pre-heat of samples. Leadfree solder, 260±5°C,	±(0.5% + 0.0005Ω)
to Soldering	210	10±1seconds immersion time. Procedure 2 for SMD: devices fluxed and	No visible damage
Heat	IEC 60115-1 4.18	cleaned with isopropanol	





# LVR Series

# Low-TCR Current Sense Chips

### DIMENSIONS

(mm)



Size	Res. Range	L	W	Н	11
0201	5mΩ - 10mΩ	0.60 ±0.03	0.31 ±0.04	0.30 ±0.05	0.15 ±0.06
0402	2.5mΩ 5mΩ ≤ R ≤ 10mΩ 12mΩ ≤ R ≤ 20mΩ	1.00 ±0.10 1.00 ±0.10 1.00 ±0.10	0.55 ±0.10 0.55 ±0.10 0.55 ±0.10	0.30 ±0.10 Max. 0.30 Max. 0.40	0.25 ±0.10 0.25 ±0.10 0.25 ±0.10

Reflow Soldering footprint							
Size	A	B C D					
0201	1.0	0.3	0.35	0.4			
0402	2.0	0.4	0.8	0.6			



#### TAPE AND REEL



#### Paper/PE tape

Size	AO	BO	w	E	F	PO	P1	P2	ØDO	т	Qty. per reel (178mm)	
0201	0.35 ±0.10	0.65 ±0.10	8.0 ±0.20	1.75 ±0.10	3.5 ±0.05	4.0 ±0.10	2.0 ±0.05	2.0 ±0.05	1.5 +0.1/-0	0.35 ±0.10*	10,000	
0402	0.59 ±0.10	1.10 ±0.10	8.00 ±0.10	1.75 ±0.10	3.50 ±0.10	4.00 ±0.10	4.00 ±0.10	2.00 ±0.10	1.55 ±0.05	0.48 ±0.03	10,000	

#### **Reel dimensions**

Qty./reel	8mm tape	Α	Ν	C	D	W1	W2 max.	
10,000	7" (Ø178mm)	178.0 ±1.0	60.0 +1/-0	13.50 ±0.5	21.0 ±0.8	9.0 ±0.5	12.0 ±0.2	

### ORDERING INFORMATION



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